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Vishay Semiconductors

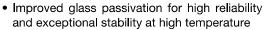
# Medium Power Phase Control Thyristors (Stud Version), 25 A



PRIMARY CHARACTERISTICS				
I <sub>T(AV)</sub>	25 A			
V <sub>DRM</sub> /V <sub>RRM</sub>	100 V, 200 V, 400 V, 600 V, 800 V, 1000 V 1200 V			
V <sub>TM</sub>	1.70 V			
I <sub>GT</sub>	60 mA			
T <sub>J</sub>	-65 °C to +125 °C			
Package	TO-48 (TO-208AA)			

Single SCR

#### **FEATURES**





- High dI/dt and dV/dt capabilities
- Standard package
- · Low thermal resistance
- · Metric threads version available
- Types up to 1200 V V<sub>DRM</sub>/V<sub>RRM</sub>
- Designed and qualified for industrial and consumer level
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

- · Medium power switching
- Phase control applications

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
		25	Α		
I <sub>T(AV)</sub>	T <sub>C</sub>	85	°C		
I <sub>T(RMS)</sub>		40	A		
I <sub>TSM</sub>	50 Hz	420	Δ.		
	60 Hz	440	A		
l <sup>2</sup> t	50 Hz	867	— A <sup>2</sup> s		
<b> -</b>	60 Hz	790	A-s		
V <sub>DRM</sub> /V <sub>RRM</sub>		100 to 1200	V		
tq	Typical	110	μs		
TJ		-65 to +125	°C		

#### **ELECTRICAL SPECIFICATIONS**

Circuit configuration

VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE <sup>(1)</sup> V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE <sup>(2)</sup> V	$\begin{aligned} I_{DRM}/I_{RRM} & \text{MAXIMUM} \\ \text{AT T}_{J} &= \text{T}_{J} & \text{MAXIMUM} \\ & \text{mA} \end{aligned}$			
	10	100	150	20			
	20	200	300				
	40	400	500				
VS-25RIA	60	600	700	10			
	80	800	900	10			
	100	1000	1100				
	120	1200	1300				

#### **Notes**

<sup>(1)</sup> Units may be broken over non-repetitively in the off-state direction without damage, if dl/dt does not exceed 20 A/µs

<sup>(2)</sup> For voltage pulses with  $t_p \le 5$  ms



<b>ABSOLUTE MAXIMUM RAT</b>	INGS					
PARAMETER	SYMBOL		TEST CONE	DITIONS	VALUES	UNITS
Maximum average on-state current at case temperature	I <sub>T(AV)</sub>	180° sinusoi	180° sinusoidal conduction		25 85	A °C
Maximum RMS on-state current	I <sub>T(RMS)</sub>				40	A
	t = 10 ms No voltage		420			
Maximum peak, one-cycle		t = 8.3 ms	reapplied		440	
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		350	A
		t = 8.3 ms	reapplied	Sinusoidal half wave,	370	
		t = 10 ms	No voltage	initial $T_J = T_J$ maximum	867	A <sup>2</sup> s
Maximum I <sup>2</sup> t for fusing	l <sup>2</sup> t	t = 8.3 ms			790	
		t = 10 ms	100 % V <sub>RRM</sub> reapplied		615	
		t = 8.3 ms			560	
Maximum I <sup>2</sup> √t for fusing	<b>l</b> ²√t	t = 0.1 to 10 ms, no voltage reapplied, $T_J = T_J$ maximum		8670	A²√s	
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x $\pi$ x $I_{T(AV)}$ < $I$ < $\pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum		0.99	V	
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.40	v
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x π	(16.7 % x $\pi$ x $I_{T(AV)}$ < $I$ < $\pi$ x $I_{T(AV)}$ ), $T_J$ = $T_J$ maximum			0
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)})$ , $T_J = T_J$ maximum		5.7	mΩ	
Maximum on-state voltage	V <sub>TM</sub>	I <sub>pk</sub> = 79 A, T <sub>J</sub> = 25 °C			1.70	V
Maximum holding current	I <sub>H</sub>	T 05 °C -	T 0500		130	1
Latching current	ΙL	$T_J = 25$ °C, anode supply 6 V, resistive load		200	mA	

SWITCHING							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
	$V_{DRM} \leq 600 \; V$			200			
Maximum rate of rise	$V_{DRM} \leq 800 \ V$		$T_J = T_J$ maximum, $V_{DM} = \text{Rated } V_{DRM}$		5 5 5	180	A/µs
of turned-on current	$V_{DRM} \leq 1000 \; V$	ui/at	Gate pulse = 20 V, 15 $\Omega$ , $t_p$ = 6 $\mu$ s, $t_r$ = 0.1 $\mu$ s maximum $I_{TM}$ = (2 x rated dl/dt) A	160	Ανμδ		
V <sub>DRM</sub> ≤ 1600 V			,	150			
Typical turn-on time		t <sub>gt</sub>	$T_J = 25$ °C, at rated $V_{DRM}/V_{RRM}$ , $T_J = 125$ °C	0.9			
Typical reverse recovery time		t <sub>rr</sub>	$T_J = T_J$ maximum, $I_{TM} = I_{T(AV)}$ , $t_p > 200 \ \mu s$ , $dI/dt = -10 \ A/\mu s$	4	μs		
Typical turn-off time		t <sub>q</sub>	$T_J=T_J \ maximum, \ I_{TM}=I_{T(AV)}, \ t_p>200 \ \mu s, \ V_R=100 \ V,$ dl/dt = - 10 A/ $\mu s$ , dV/dt = 20 V/ $\mu s$ linear to 67 % V <sub>DRM</sub> , gate bias 0 V to 100 W	110	μΟ		

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise	dV/dt	$T_J = T_J$ maximum linear to 100 % rated $V_{DRM}$	100	V/us
of off-state voltage	uv/di	$T_J = T_J$ maximum linear to 67 % rated $V_{DRM}$	300 (1)	v/μS

#### Note

<sup>(1)</sup> Available with:  $dV/dt = 1000 V/\mu s$ , to complete code add S90 i.e. 25RIA120S90



TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum peak gate power	P <sub>GM</sub>	T T		8.0	W
Maximum average gate power	P <sub>G(AV)</sub>	- IJ = IJ Maximum	$T_J = T_J$ maximum		
Maximum peak positive gate current	I <sub>GM</sub>	$T_J = T_J$ maximum		1.5	Α
Maximum peak negative gate voltage	-V <sub>GM</sub>	$T_J = T_J$ maximum		10	V
		T <sub>J</sub> = - 65 °C		90	
DC gate current required to trigger	l <sub>GT</sub>	T <sub>J</sub> = 25 °C	Maximum required gate trigger current/voltage are the lowest value which will trigger all units 6 V anode to cathode applied	60	mA
		T <sub>J</sub> = 125 °C		35	
	V <sub>GT</sub>	T <sub>J</sub> = - 65 °C		3.0	V
DC gate voltage required to trigger		T <sub>J</sub> = 25 °C		2.0	
		T <sub>J</sub> = 125 °C		1.0	
DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = T <sub>J</sub> maximum, V <sub>DRM</sub> = Rated value		2.0	mA
DC gate voltage not to trigger	$V_{GD}$	$T_J = T_J$ maximum, $V_{DRM} = Rated value$	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V <sub>DRM</sub> anode to cathode applied	0.2	V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +125	ů	
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	0.75	K/W	
Maximum thermal resistance, case to heat sink	R <sub>thCS</sub>	Mounting surface, smooth, flat and greased		r./ vv	
Allowable mounting torque		Non-lubricated threads	3.4 + 0 - 10 % (30)	N⋅m	
Allowable mounting torque		Lubricated threads	2.3 + 0 - 10 % (20)	(lbf · in)	
Approximate weight			14	g	
Approximate weight			0.49	oz.	
Case style		See dimensions - link at the end of datasheet	ensions - link at the end of datasheet TO-48 (TO-208AA		

△R <sub>thJC</sub> CONDUCTION				
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS
180°	0.17	0.13		
120°	0.21	0.22		
90°	0.27	0.30	$T_J = T_J$ maximum	K/W
60°	0.40	0.42		
30°	0.69	0.70		

#### Note

The table above shows the increment of thermal resistance R<sub>thJC</sub> when devices operate at different conduction angles than DC

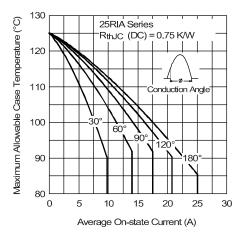


Fig. 1 - Current Ratings Characteristics

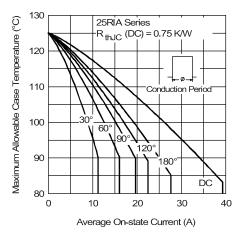


Fig. 1 - Current Ratings Characteristics

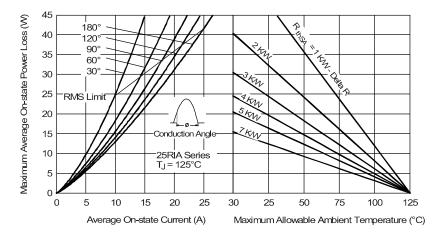


Fig. 2 - On-State Power Loss Characteristics

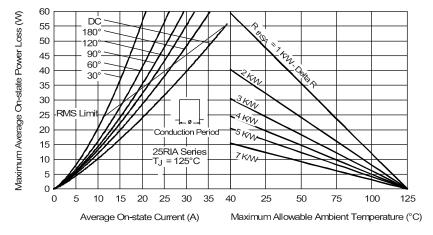


Fig. 3 - On-State Power Loss Characteristics

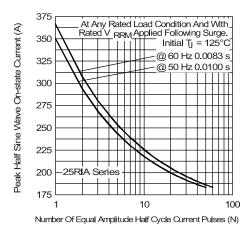


Fig. 4 - Maximum Non-Repetitive Surge Current

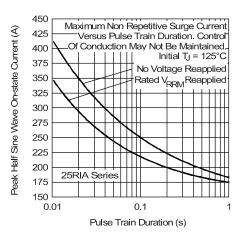


Fig. 5 - Maximum Non-Repetitive Surge Current

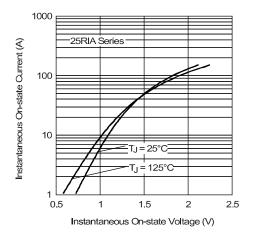


Fig. 6 - Forward Voltage Drop Characteristics

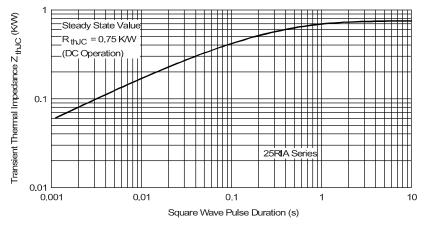


Fig. 7 - Thermal Impedance  $Z_{\text{thJC}}$  Characteristics

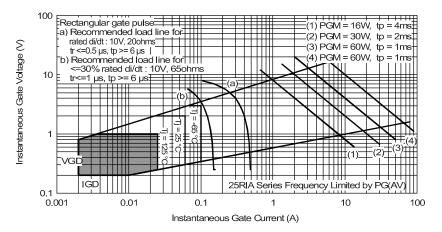
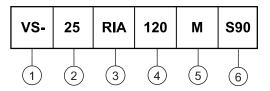


Fig. 8 - Gate Characteristics

#### **ORDERING INFORMATION TABLE**

Device code



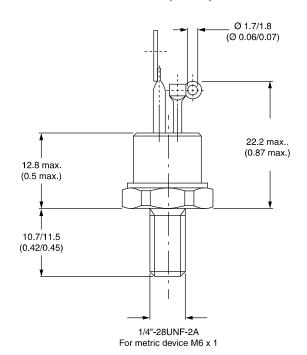
- 1 Vishay Semiconductors product
- 2 Current code
- 3 Essential part number
- Voltage code x 10 = V<sub>RRM</sub> (see Voltage Ratings table)
- None = stud base TO-48 (TO-208AA) 1/4" 28UNF-2A
   M = stud base TO-48 (TO-208AA) M6 x 1
- 6 Critical dV/dt:
  None = 300 V/µs (standard value)
  S90 = 1000 V/µs (special selection)

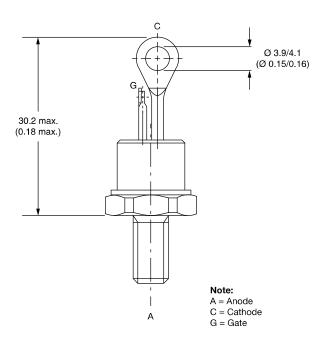
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95333

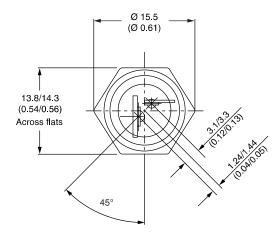


# TO-208AA (TO-48)

#### **DIMENSIONS** in millimeters (inches)









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